

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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EPAS ID: PAT6708472

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KARI RINKO	02/12/2018
LEO HATJASALO	02/12/2018
JAANA JAHKONEN	02/12/2018
RECEIVING PARTY DATA	
Name:	OY MTG-MELTRON LTD
Street Address:	LAIVAKATU 3
City:	HELSINKI
State/Country:	FINLAND
Postal Code:	00150
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16745401
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	7709339500
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Address Line 4:	ATLANTA, GEORGIA 30339
ATTORNEY DOCKET NUMBER:	220208-1620
NAME OF SUBMITTER:	SALLY SEXTON
SIGNATURE:	/sally sexton/
DATE SIGNED:	05/13/2021
Total Attachments: 5	
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PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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EPAS ID: PAT4889641

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KARI RINKO	02/12/2018
LEO HATJASALO	02/12/2018
JAANA JAHKONEN	02/12/2018
RECEIVING PARTY DATA	
Name:	OY MTG-MELTRON LTD
Street Address:	LAIVAKATU 3
City:	HELSINKI
State/Country:	FINLAND
Postal Code:	00150
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15570492
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Correspondent Name:	BERGGREN LLP
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Address Line 4:	HOBOKEN, NEW JERSEY 07030
ATTORNEY DOCKET NUMBER:	PI100416
NAME OF SUBMITTER:	SANGKYUNG LEE
SIGNATURE:	/Sangkyung Lee/
DATE SIGNED:	03/29/2018
Total Attachments: 4	
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ASSIGNMENT

WHEREAS, WE:

RINKO, Kari, residing at
Myllytie 3 A 9, 00140 Helsinki, Finland

HATJASALO, Leo, residing at
Vattuniemenkatu 10 C, 00120 Helsinki, Finland

JAHKONEN, Jaana, residing at
Piilipuuntie 3 C 45, 02250 Espoo, Finland

(hereinafter ASSIGNORS), are the inventors of the invention described in U.S. Patent Application entitled:

MODULAR LUMINAIRE, RELATED MODULE, SYSTEM AND LIGHTING APPARATUS

having the application number 15/570,492 filed on October 30, 2017.

WHEREAS, WE covenant that the rights and property herein conveyed are free and clear of any encumbrance, and that we have the full right to convey the same as herein expressed.

WHEREAS, OY MTG-MELTRON LTD, having a place of business at Laivakatu 3, 00150 Helsinki, Finland, and its successors, assigns and legal representatives (hereinafter ASSIGNEE), is desirous of obtaining the ASSIGNORS' entire right, title and interest in, to and under the invention disclosed in said application;

NOW, THEREFORE, for good and valuable consideration of the sum of one dollar (\$1), sufficiency and receipt of which is hereby acknowledged, we said ASSIGNORS do hereby sell, assign and transfer or confirm the grant and assignment to said ASSIGNEE our right, title and interest in all countries of the world in and to our invention described in said application for Patents, in and to the right to file patent application in the name of ASSIGNEE, its designees, or in any or all of our names, at its election, on the aforesaid invention in all countries of the world, together with all rights of priority in the aforesaid countries deriving from the above-identified application for Patents under the Paris Convention for the Protection of Industrial Property, under the Inter-American Convention relating to Inventions, Patents, Designs and Industrial Models and under any other international arrangement relating to patents or intellectual property, in and to any and all Letters Patent that are granted from the aforesaid application for Patents, in and to any application claiming priority benefits to the patent application or other applications filed on said invention, and in and to any continuations, divisions, reexaminations, reissues, renewals and extensions thereof of any said Letters Patent, the same to be held and enjoyed by said ASSIGNEE, to the full ends of the terms for which all Letters Patent therefore may be granted, as fully and entirely as the same would have been held and enjoyed by ourselves if this assignment and sale had not been made.

AND WE HEREBY covenant and agree that we will at any time, upon the request and at the expense of ASSIGNEE, without further compensation or charge to said ASSIGNEE, execute and deliver

any and all documents that may be necessary or desirable to perfect the title to the foregoing invention, patent applications, and Letters Patent and continuations, divisions, reexaminations, reissues, renewals and extensions thereof in the name of ASSIGNEE, including the procurement of any and all further documents evidencing this assignment and sale as may be necessary or desirable for recording the same in the Patent Office of any country concerned, and will make all rightful oaths and declarations and do all lawful acts requisite for procuring the same or for aiding therein.

AND WE HEREBY authorize and request from the Commissioner of Patents of the United States, and of any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention or improvements to said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY further covenant and agree that we will communicate to ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, reissue, continuation and continuation-in-part applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention or improvements in all countries.

AND WE HEREBY further grant the firm Berggren Inc. of 221 River St., 9th Floor, Hoboken, NJ 07030, USA the power to insert on this Assignment any further indication, including the application serial number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

This document may be executed in any number of counterparts, each of which so executed shall be deemed to be an original, but all such components shall together constitute but one and the same document.

Executed this 12 day of February, 2017



Kari RINKO, Inventor

Witnessed by: _____
Printed name: _____

Date: _____

Witnessed by: _____
Printed name: _____

Date: _____

Executed this 12th day of February, 2017



Leo HATIASALO, Inventor


Witnessed by: _____
Printed name: _____

Date: _____

Witnessed by: _____
Printed name: _____

Date: _____

Executed this 12 day of February, 2018



Jaana JAHKONEN, Inventor

Witnessed by: _____
Printed name: _____

Date: _____

Witnessed by: _____
Printed name: _____

Date: _____